PROJEK DEVICES

LCD05C thru LCD24C

LOW CAPACITANCE TVS ARRAY

APPLICATIONS

- ✓ Ethernet 10/100 Base T
- ✔ RS-458
- ✓ xDSL & ATM
- ✓ SCSI & USB
- ✔ Audio/Video I/O Ports

IEC COMPATIBILITY (EN61000-4)

- ✓ 61000-4-4 (EFT): 40A 5/50ns
- ✓ 61000-4-5 (Surge): 24A, 8/20µs Level 2 (Line-Ground) & Level 3 (Line-Line)

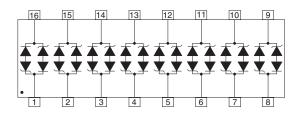
FEATURES

- ✓ 800 Watts Peak Pulse Power per Line (tp=8/20µs)
- ✓ Bidirectional Configuration
- ✓ ESD Protection > 40 kilovolts
- ✓ Available in 5 Voltage Types: 5V to 24V
- ✓ Standard Dual-In-Line Package
- ✔ Protects up to 8 Lines
- ✔ Low Capacitance: 15pF
- ✔ RoHS Compliant

MECHANICAL CHARACTERISTICS

- ✓ Molded 16 Pin Dual-In-Line (DIP) Package
- ✓ Weight 1.2 grams (Approximate)
- ✓ Available in Lead-Free Pure-Tin Plating(Annealed)
- ✓ Solder Reflow Temperature:
 - Pure-Tin Sn, 100: 260-270°C
- ✔ Consult Factory for Leaded Device Availability
- ✔ Flammability Rating UL 94V-0
- ✔ Packaging: 25 Pieces Per Tube
- ✓ Marking: Logo, Part Number, Date Code & Pin One Defined By Dot on Top of Package

PIN CONFIGURATION



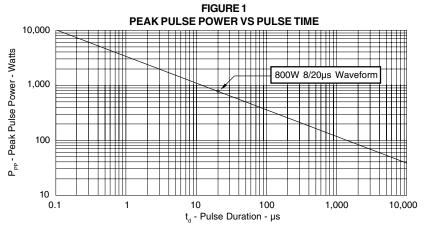


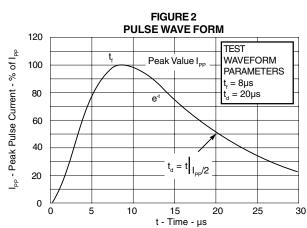
DEVICE CHARACTERISTICS

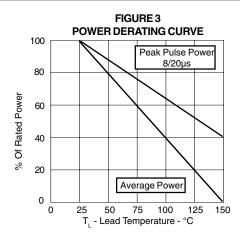
| MAXIMUM RATINGS @ 25°C Unless Otherwise Specified | | | | | | | |
|---|------------------|------------|------------|--|--|--|--|
| PARAMETER | SYMBOL | VALUE | UNITS | | | | |
| Peak Pulse Power (t _D = 8/20μs) - See Figure 1 | P_{PP} | 800 | Watts | | | | |
| Operating Temperature | T _L | -55 to 150 | $^{\circ}$ | | | | |
| Storage Temperature | T _{STG} | -55 to 150 | ℃ | | | | |

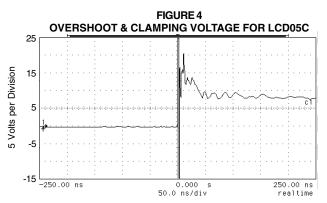
| ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified | | | | | | | |
|---|------------------------------------|-------------------------------------|--|---|-------------------------------|----------------------------|--|
| PART NUMBER (See Note 1) | RATED STAND-OFF VOLTAGE | MINIMUM BREAKDOWN VOLTAGE | MAXIMUM CLAMPING VOLTAGE (See Fig. 2) | MAXIMUM CLAMPING VOLTAGE (See Fig. 2) | MAXIMUM LEAKAGE CURRENT | MAXIMUM CAPACITANCE | TEMPERATURE COEFFICIENT OF V _(BR) |
| | V _{wm} VOLTS | @ 1mA V _(BR) VOLTS | @ I _P = 1A V _C VOLTS | @ 8/20μs V _C @ Ι _{ΡΡ} | @V _{wм} Ц µА | 0V @ 1 MHz C pF | qV _(BR) mV/°C |
| LCD05C LCD08C LCD12C LCD15C LCD24C | 5.0 8.0 12.0 15.0 24.0 | 6.0 8.5 13.3 16.7 26.7 | 9.8 12.3 19.0 25.5 40.0 | 24V @ 45A 25.5V @ 40A 32V @ 34A 38V @ 27A 48V @ 22A | 100 10 4 4 4 | 15 15 15 15 15 | 3 9 16 17 26 |

Note 1: Tested on pin pairs 1 & 16, 2 & 15, 3 & 14, 4 & 13, 5 & 12, 6 & 11, 7 & 10 and 8 & 9.

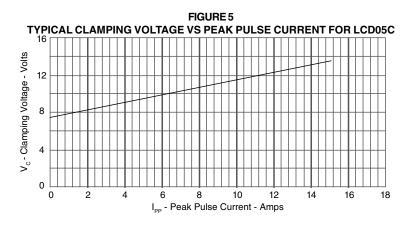








ESD Test Pulse: 12 kilovolt, 1/30ns (waveform)



APPLICATION NOTE

The LCD Series are low capacitance, bidirectional TVS arrays that are designed to protect I/O or high speed data lines from the damaging effects of ESD or EFT. This product series has a surge capability of 800 Watts P_{PP} per line for an 8/20µs waveshape and offers ESD protection > 40kV.

BIDIRECTIONAL COMMON-MODE CONFIGURATION (Figure 1)

Ideal for use in USB applications, the LCD Series provides up to eight (8) lines of protection in a common-mode configuration as depicted in Figure 1.

Circuit connectivity is as follows:

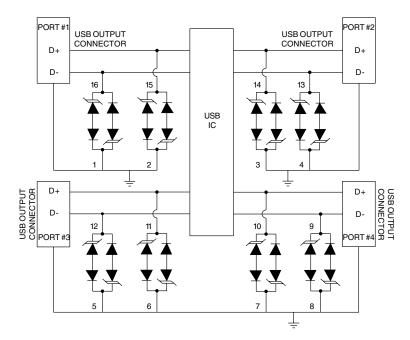
- ✓ Pins 2, 3, 4, 5, 6, and 7 are connected to ground.
- ✔ Pins 15 and 14 connected to Port #1 D- and D+.
- ✓ Pins 13 and 12 connected to Port #2 D+ and D-.
- ✓ Pins 11 and 10 connected to Port #3 D+ and D-.

CIRCUIT BOARD LAYOUT RECOMMENDATIONS

Circuit board layout is critical for Electromagnetic Compatibility (EMC) protection. The following guidelines are recommended:

- The protection device should be placed near the input terminals or connectors. By placing the TVS close to the connectors, the device will divert the transient current immediately before it can be coupled into the nearby traces.
- The path length between the TVS devices and the protected line should be minimized
- All conductive loops including power and ground loops should be minimized
- The transient current return path to ground should be kept as short as possible to reduce parasitic inductance.
- Ground planes should be used whenever possible.
 For Multilayer PCBs, use ground vias.

Figure 1. Typical Common-Mode USB Protection Circuit



LCD05C LCD24C

16 PIN DIP PACKAGE OUTLINE & DIMENSIONS

PACKAGE OUTLINE Orientation Dot (Pin #1) 12 Places 2 Places 16 Places 16 Places



| DIMENSIONS | | | | | | |
|------------|----------|----------|-----------|-----------|--|--|
| | MILLIM | ETERS | INCHES | | | |
| DIM | MIN | MAX | MIN | MAX | | |
| Α | - | 19.8 | - | 0.780 | | |
| В | 7.37 | 7.87 | 0.290 | 0.310 | | |
| С | 6.10 | 6.60 | 0.240 | 0.260 | | |
| D | 0.25 | 0.50 | 0.010 | 0.020 | | |
| E | 0° | 10° | 0° | 10° | | |
| F | 0.51 | - | 0.020 | - | | |
| G | - | 5.08 | - | 0.200 | | |
| Н | 3.17 | - | 0.125 | - | | |
| 1 | - | 1.78 | - | 0.070 | | |
| J | 0.84 TYP | 0.84 TYP | 0.033 TYP | 0.033 TYP | | |
| K | 0.38 | 0.53 | 0.015 | 0.021 | | |
| L | 2.54 TYP | 2.54 TYP | 0.100 TYP | 0.100 TYP | | |

NOTES:

1. Dimensions are exclusive of mold flash and metal burrs.

BULK ORDERING NOMENCLATURE:

- 1. No Suffix = Product Shipped in Tubes of 25 pcs per Tube.
- 2. Suffix LF = Lead-Free, Pure-Tin Plating, i.e., LCD05C-LF.

Outline & Dimensions: Rev 1 - 11/01, 06003

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